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FGH75T65SHDTL4 650 V, 75 A Field Stop Trench IGBT

Features

- Maximum Junction Temperature: T_J =175^oC
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)}$ =1.6 V(Typ.) @ I_C = 75 A
- 100% of the Parts Tested for I_{LM}(1)
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- Pb Free and RoHS Compliant
- Do Not Recommend for Reflow and Full PKG Dipping

General Description

Using novel field stop IGBT technology, Fairchild's new series of field stop 3rd generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

Applications

• Solar Inverter, UPS, Welder, Telecom, ESS, PFC





E1: Kelvin Emitter E2: Power Emitter

Absolute Maximum Ratings T_c = 25°C unless otherwise noted

Symbol	Description		FGH75T65SHDTL4	Unit
V _{CES}	Collector to Emitter Voltage		650	V
	Gate to Emitter Voltage		± 20	V
VGES	Transient Gate to Emitter Voltage		± 30	V
	Collector Current	@ T _C = 25 ^o C	150	A
10	Collector Current	@ T _C = 100°C	75	A
I _{LM (1)}	Pulsed Collector Current	@ T _C = 25 ^o C	300	A
I _{CM (2)}	Pulsed Collector Current		300	A
le.	Diode Forward Current	@ T _C = 25°C	125	A
۰F	Diode Forward Current	@ T _C = 100 ^o C	75	A
I _{FM (2)}	Pulsed Diode Maximum Forward Curre	nt	300	A
Po	Maximum Power Dissipation	@ T _C = 25°C	455	W
· D	Maximum Power Dissipation	@ T _C = 100°C	227	W
TJ	Operating Junction Temperature		-55 to +175	°C
T _{stg}	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds	5	300	°C

Notes:

1. V_{CC} = 400 V, V_{GE} = 15 V, I_C = 300 A, R_G = 73 $\Omega,$ Inductive Load

2. Repetitive rating: Pulse width limited by max. junction temperature

November 2015

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Thermal Characteristics

Symbol	Parameter	FGH75T65SHDTL4	Unit
R _{θJC} (IGBT)	Thermal Resistance, Junction to Case, Max.	0.33	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	0.65	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH75T65SHDTL4	FGH75T65SHDTL4	TO-247 A04	Tube	-	-	30

Electrical Characteristics of the IGBT $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	teristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0V, I_C = 1 \text{ mA}$	650	-	-	V
$\Delta BV_{CES} / \Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	$I_{\rm C}$ = 1 mA, Reference to 25°C	-	0.65	-	V/ºC
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
On Charac	teristics					
V _{GE(th)}	G-E Threshold Voltage	I _C = 75 mA, V _{CE} = V _{GE}	4.0	5.5	7.5	V
		I _C = 75 A, V _{GE} = 15 V	-	1.6	2.1	V
V _{CE(sat)} Collector to Emitter Saturation Voltage		$I_{C} = 75 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 175^{\circ}\text{C}$	-	2.28	-	V
Dynamic C	haracteristics					
C _{ies}	Input Capacitance		-	3710	-	pF
C _{oes}	Output Capacitance	$V_{CE} = 30 V_{V_{GE}} = 0 V_{V_{FE}}$	-	183	-	pF
C _{res}	Reverse Transfer Capacitance		-	43	-	pF
Switching	Characteristics					
t _{d(on)}	Turn-On Delay Time		-	55	-	ns
t _r	Rise Time		-	50	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{CC} = 400 V, I _C = 75 A,	-	189	-	ns
t _f	Fall Time	$R_G = 15 \Omega$, $V_{GE} = 15 V$,	-	39	-	ns
Eon	Turn-On Switching Loss	Inductive Load, $I_C = 25^{\circ}C$	-	1.06	-	mJ
E _{off}	Turn-Off Switching Loss		-	1.56		mJ
E _{ts}	Total Switching Loss		-	2.62	-	mJ
t _{d(on)}	Turn-On Delay Time		-	48	-	ns
t _r	Rise Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 75 \text{ A},$ R _G = 15 Ω, V _{GE} = 15 V,	-	56	-	ns
t _{d(off)}	Turn-Off Delay Time		-	205	-	ns
t _f	Fall Time		-	40	-	ns
Eon	Turn-On Switching Loss		-	2.34	-	mJ
E _{off}	Turn-Off Switching Loss		-	1.81	-	mJ
E _{ts}	Total Switching Loss		-	4.15	-	mJ

Electrical Characteristics of the IGBT (Continued)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge		-	126	-	nC
Q _{ge}	Gate to Emitter Charge	$V_{CE} = 400 \text{ V}, \text{ I}_{C} = 75 \text{ A},$	-	24.1	-	nC
Q _{gc}	Gate to Collector Charge	VGE - 13 V	-	47.6	-	nC

Electrical Characteristics of the Diode $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Test Condition	ns	Min.	Тур.	Max	Unit
V	Diode Forward Voltage	I _F = 75 A	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	1.8	2.1	V	
* FIM	blodd i officiald voltage		071	$T_{\rm C} = 175^{\rm o}{\rm C}$	-	1.7	-	
E _{rec}	Reverse Recovery Energy			$T_{\rm C} = 175^{\rm o}{\rm C}$	-	160	-	uJ
t	Diode Reverse Recovery Time	 7	75 A dl_/dt - 200 A/us	$T_C = 25^{\circ}C$	-	76	-	ns
٩r		$r_F = 75 \text{ A}, \text{ dr}/\text{ar} = 200 \text{ A}/\mu S$	$T_{\rm C} = 175^{\rm o}{\rm C}$	-	270	-		
0	Diode Reverse Recovery Charge			$T_C = 25^{\circ}C$	-	206	-	nC
G IL	bloud neveloc needrory charge			$T_{\rm C} = 175^{\rm o}{\rm C}$	-	2199	-	

Typical Performance Characteristics









Figure 5. Saturation Voltage vs. V_{GE}



Figure 2. Typical Output Characteristics













Typical Performance Characteristics Figure 8. Gate charge Characteristics **Figure 7. Capacitance Characteristics** 10000 15 Common Emitter T_C = 25^oC Gate-Emitter Voltage, V_{GE} [V] 8 0 6 71 Cies 300V Capacitance [pF] 1000 $V_{CC} = 200V$ 400V Cof 100 Cres **Common Emitter** V_{GE} = 0V, f = 1MHz $T_C = 25^{\circ}C$ 10 0 10 30 25 50 75 100 125 150 0 1 Collector-Emitter Voltage, VCE [V] Gate Charge, Q_g [nC] Figure 9. Turn-on Characteristics vs. Figure 10. Turn-off Characteristics vs. **Gate Resistance** Gate Resistance 1000 400 Common Emitter V_{CC} = 400V, V_{GE} = 15V I_C = 75A t_{d(off)} $T_{C} = 25^{\circ}C$ — Switching Time [ns] Switching Time [ns] T_C = 175^oC ... t 100 100 Common Emitter $V_{CC} = 400V, V_{GE} = 15V$ I_C = 75A $T_{C} = 25^{\circ}C$ -T_C = 175°C 10 └-10 30 40 50 20 30 10 30 40 50 20 Gate Resistance, $R_G [\Omega]$ Gate Resistance, $R_G [\Omega]$ Figure 11. Switching Loss vs. Figure 12. Turn-on Characteristics vs. **Gate Resistance Collector Current** 100 5 t_{d(on)} Switching Time [ns] Switching Loss [mJ] E_{on} **Common Emitter** 1 V_{CC} = 400V, V_{GE} = 15V Common Emitter I_C = 75A $V_{GE} = 15V, R_G = 15\Omega$ $T_{c} = 25^{\circ}C$ — T_c = 25°C ____ 10 T_C = 175°C ... = 175°C T_c 0.4 └-10 8 15 30 45 60 75 20 30 40 50 Collector Current, I_C [A] Gate Resistance, R_G [Ω]

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